

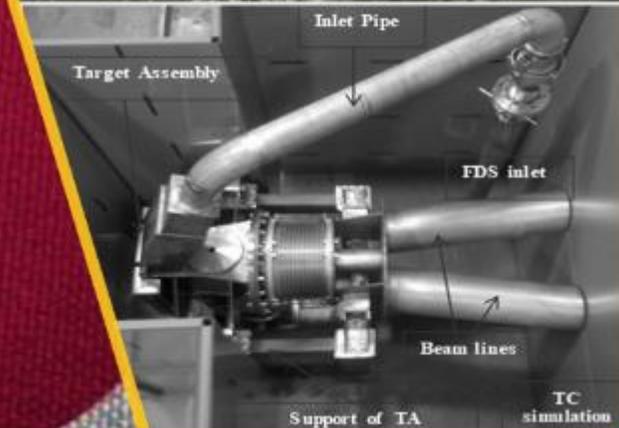
LIPAc RFカプラにおける電子マルチパクタおよびそれに対する磁気バイアスの効果についてのシミュレーション

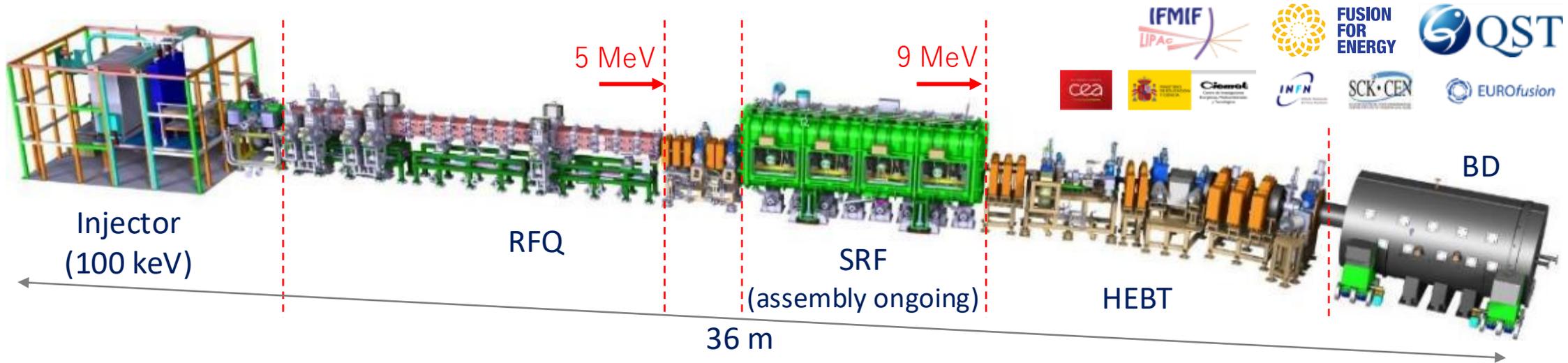
Electron simulation about multipactor and effect of magnetic bias in LIPAc RF couplers

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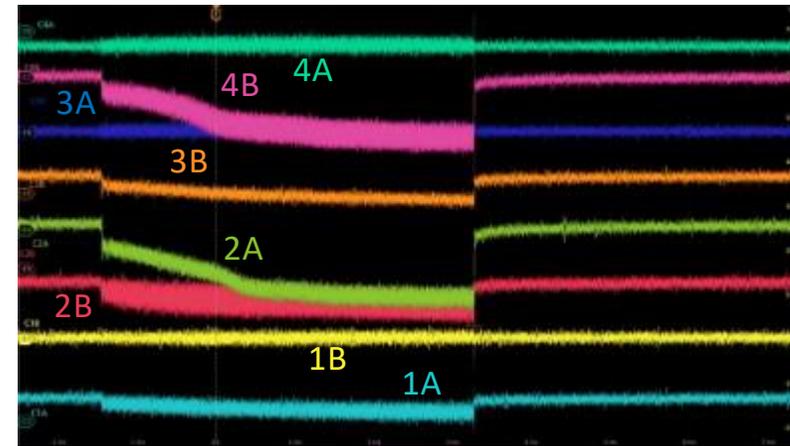
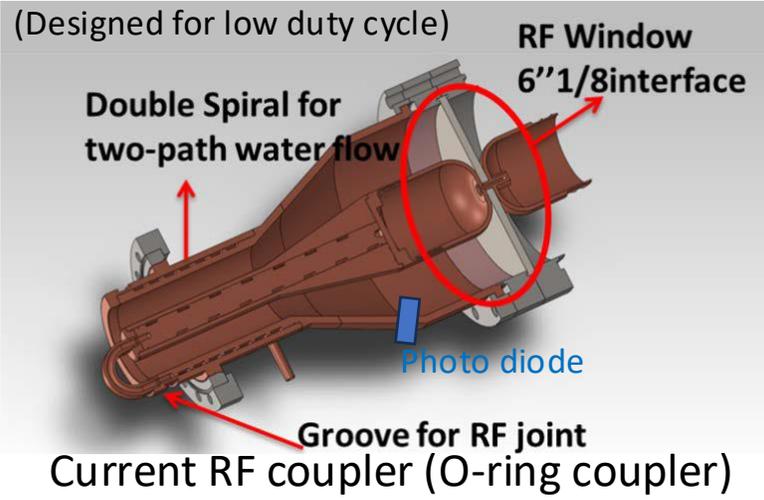
22-th PASJ annual meeting (2025)
Tokyo city univ., Japan 06-08 Aug. 2025





IFMIF: International Fusion Materials Irradiation Facility LIPAc: Linear IFMIF Prototype Accelerator

	IFMIF	LIPAc
Current	125 mA × 2 lines	125 mA × 1 line
Energy	40 MeV	9 MeV
Acceleration Line	RFQ + 4 SRF	RFQ + 1 SRF
Target	Li	Cu



8 couplers,
160-180 kW for
each in nominal

Damaged O-ring at the RF window

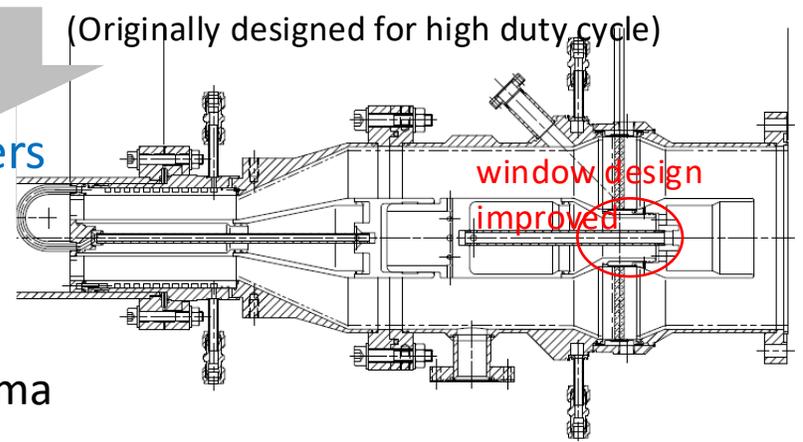
Observed light emission

Overheating, damage of O-rings, and light emissions observed

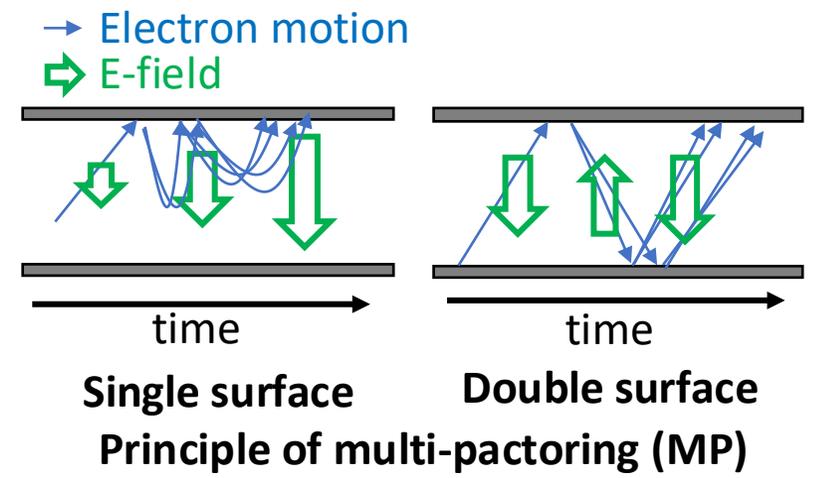
- Duty cycle limited < 10%
- Multi-pactoring (MP) is suspected as a major cause.

Test of a set of new RF couplers (brazed coupler) is ongoing

- Reduce axial field around the window to relax MP
- Improve its durability to plasma expose and thermal stress



Testing new couplers (brazed coupler)



Single surface Double surface
Principle of multi-pactoring (MP)

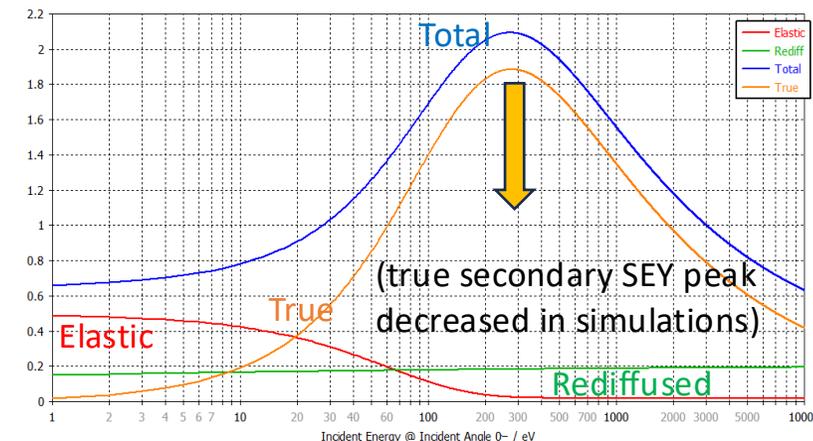
Purpose

- Analyze the MP conditions in both old and new couplers to support testing of the new coupler
- Establish an alternative countermeasure to control MP

Method

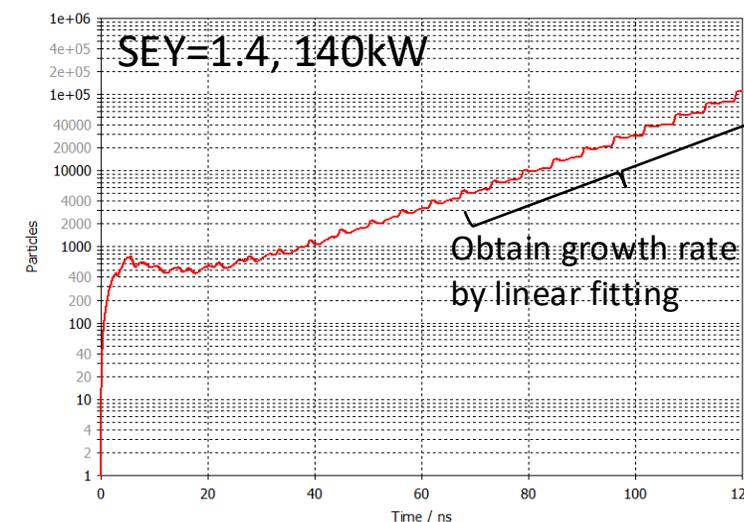
MP simulation with electromagnetic particle simulations using the CST-Studio suite[®] (Charged Particle Dynamics solver)

- Comparison of MP between O-ring and brazed couplers
- MP control by the axial B-field bias



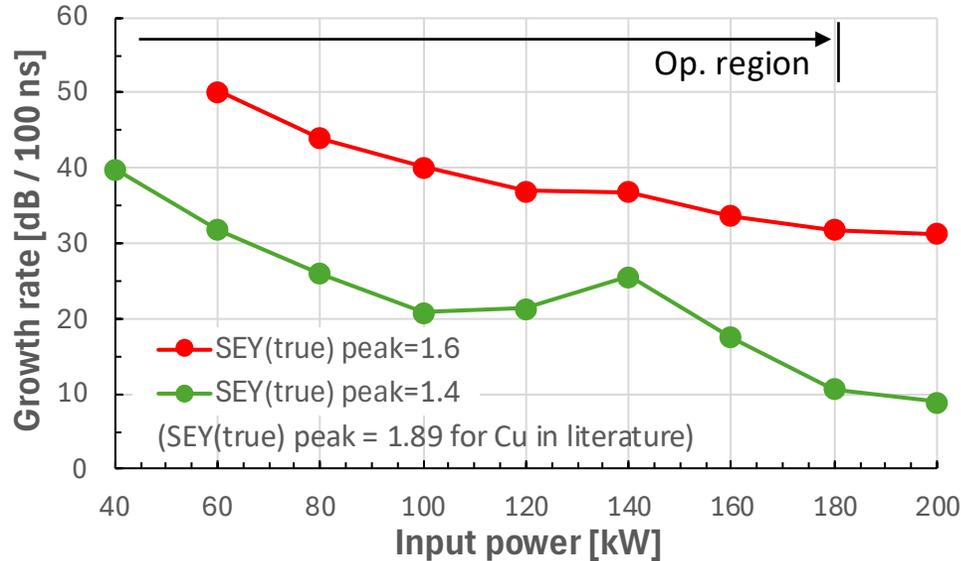
Energy dependency of 2ndary emission of Cu* (also using same one for ceramic window)

*M.A. Furman and M. T. F. Pivi, LBNL-52807, SLAC-PUB-9912

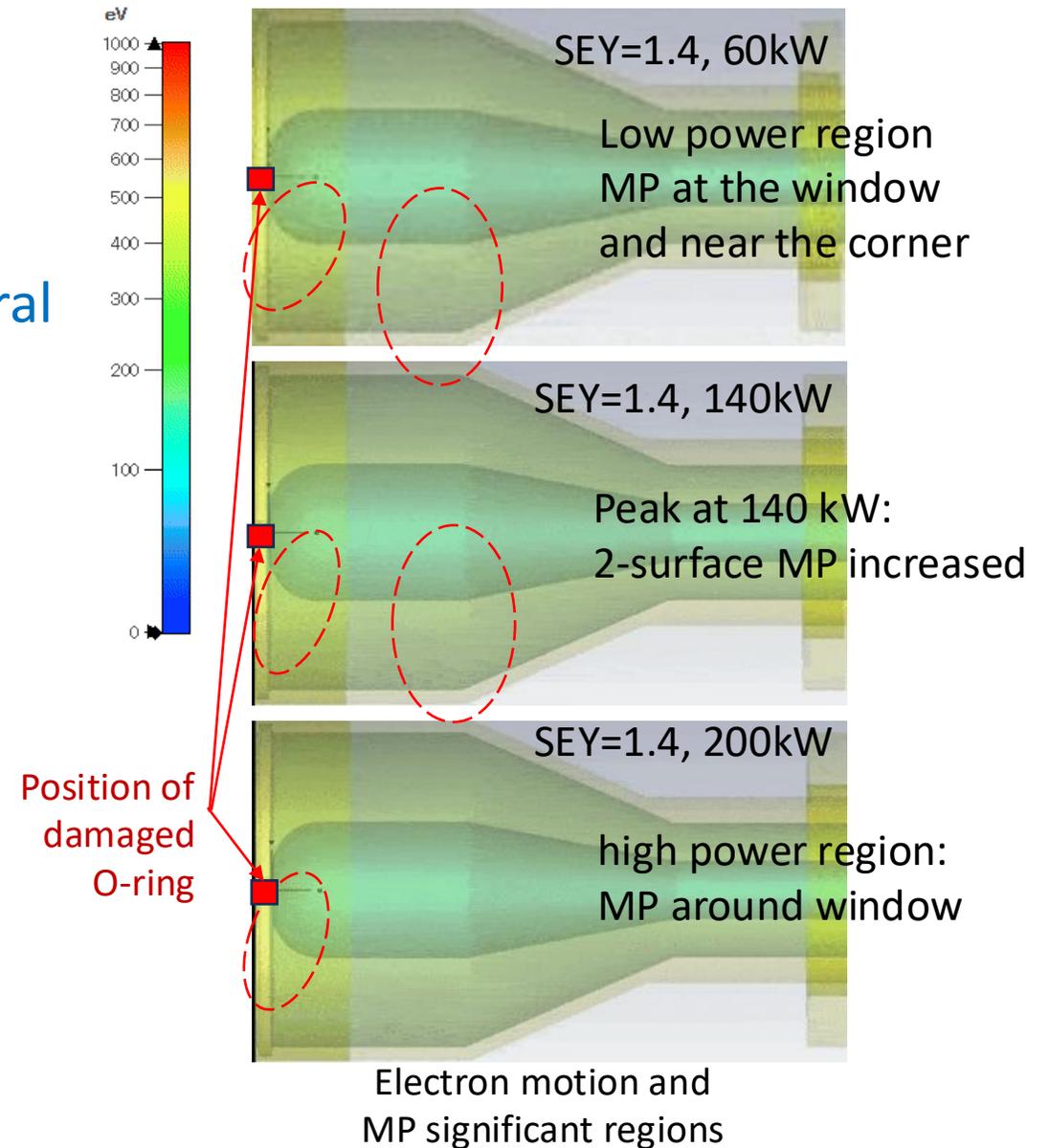


Typical case of electron number growth

- MP caused around the ceramic window on the entire power level until 200 kW
 - Near the damaged O-ring
- MP is likely to be strong in the areas of structural changes.
 - Around the window and a corner in this case

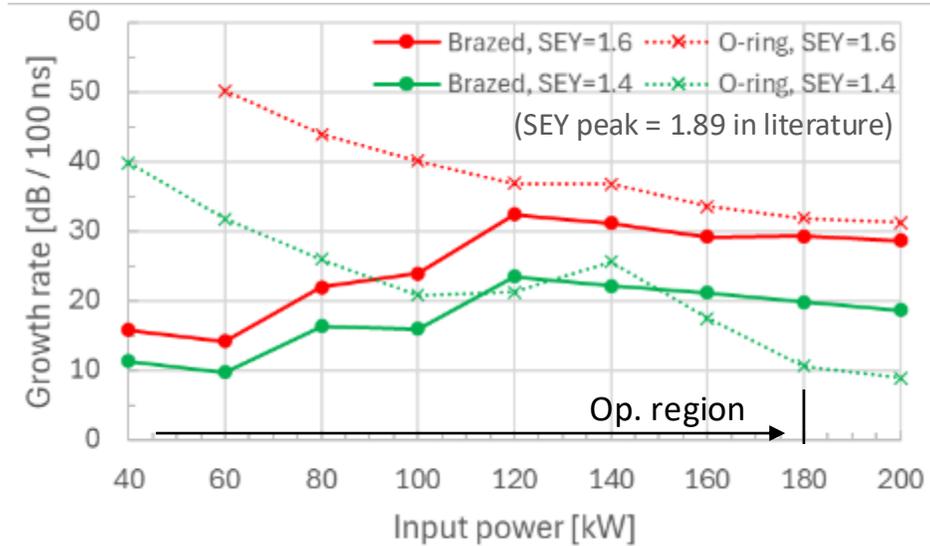


Growth rate of the electron number by MP



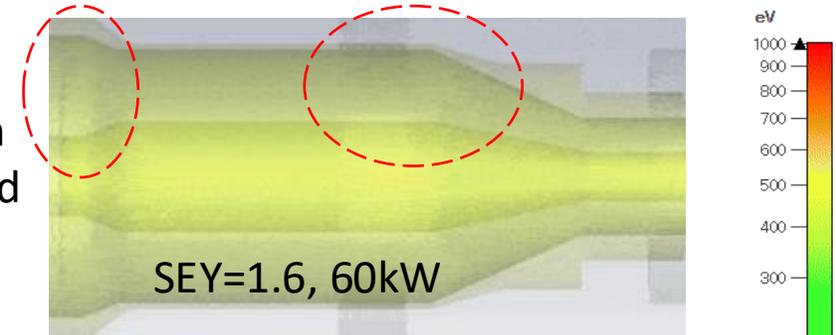
The electron number growth rate notably decreases compared with that in the O-ring coupler.

- Improved especially in the lower-power side while not so remarkable in high power region.
- Improved in the entire region of input power with high (but still lower than literal) SEY
- Still the MP-free (growth rate < 0) not achieved
- MP associated with the motion of electrons like rubbing on the window surface still exists

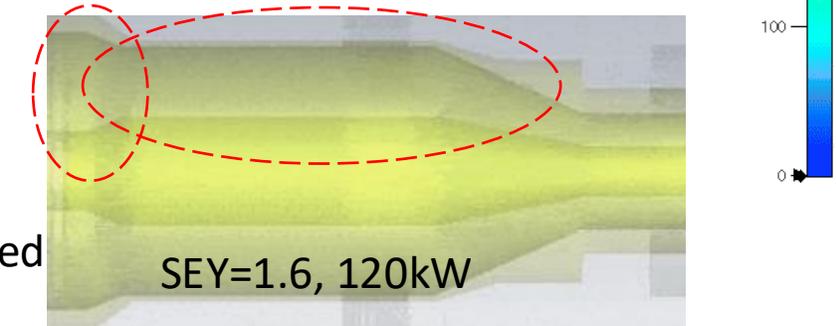


Comparison of growth rate

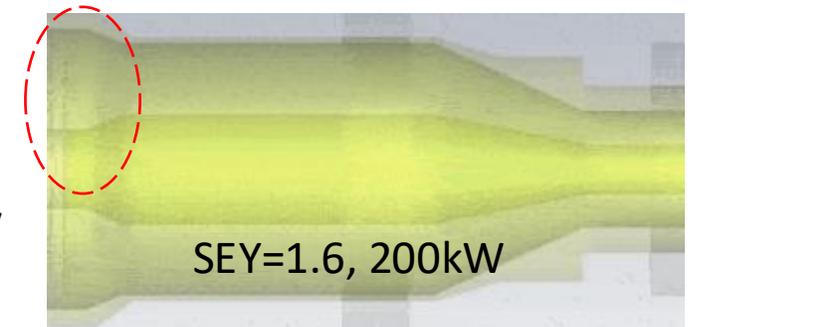
Low power region
MP at window and
edge of cone



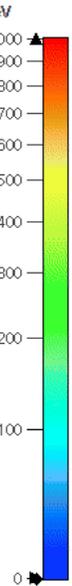
Peak at 120 kW:
2-surface MP increased



high power region:
MP around window



Electron motion and MP regions



Control of the MP by the axial B-fields

- Suppress the energy gain of electrons from potential change until re-injection to the wall surface.

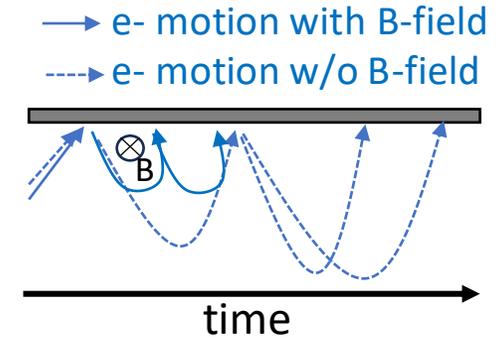
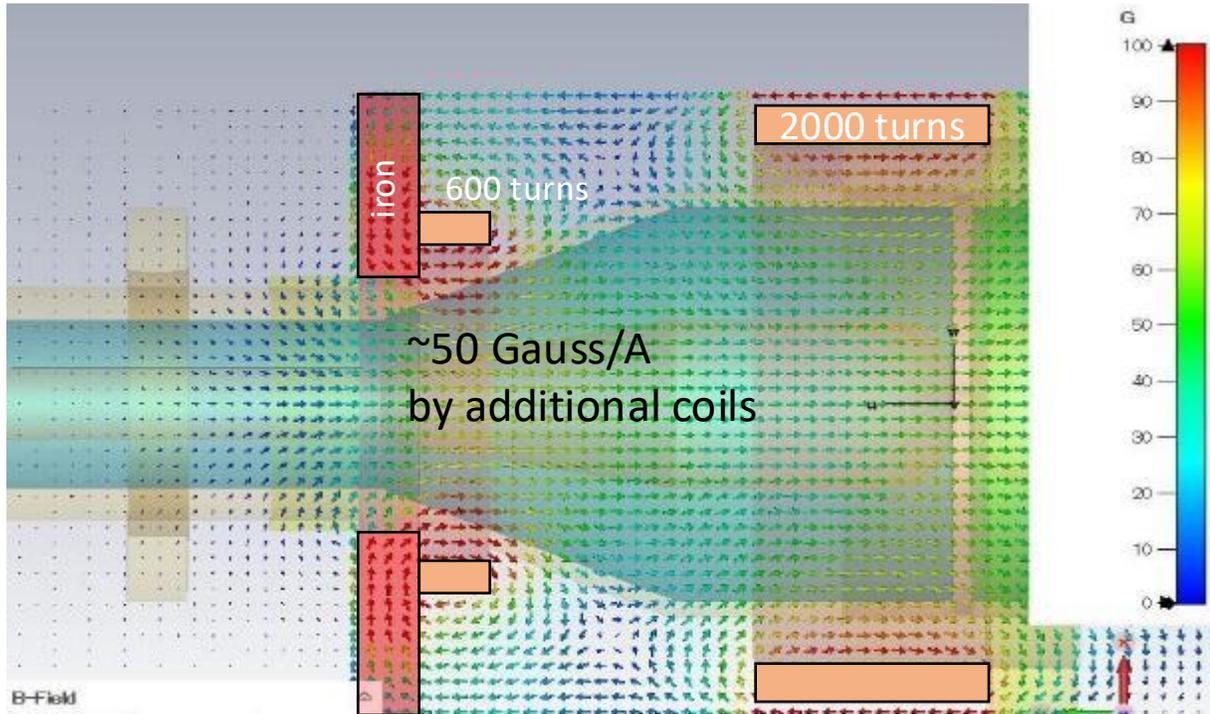
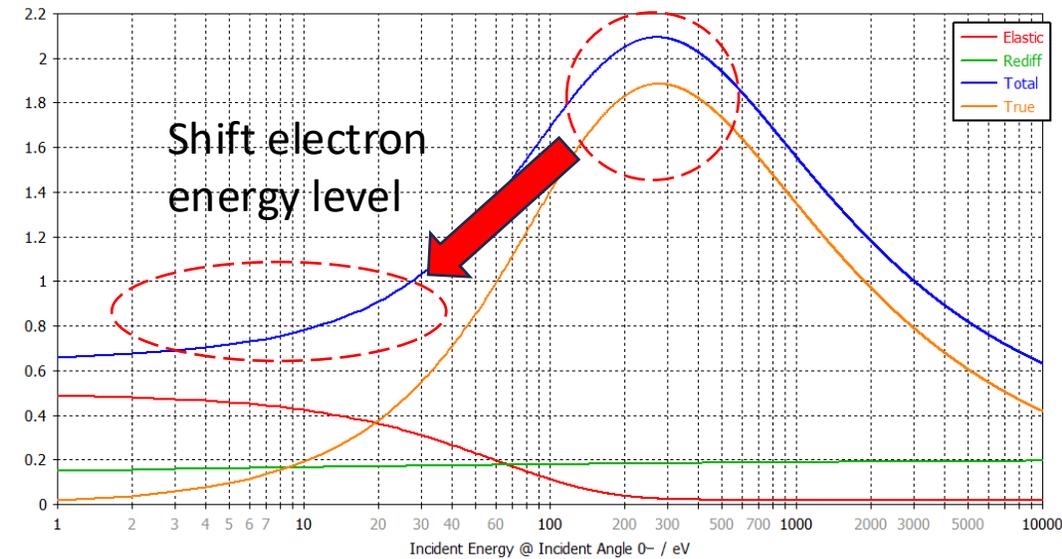


Image of electron motion with and without bias B-field



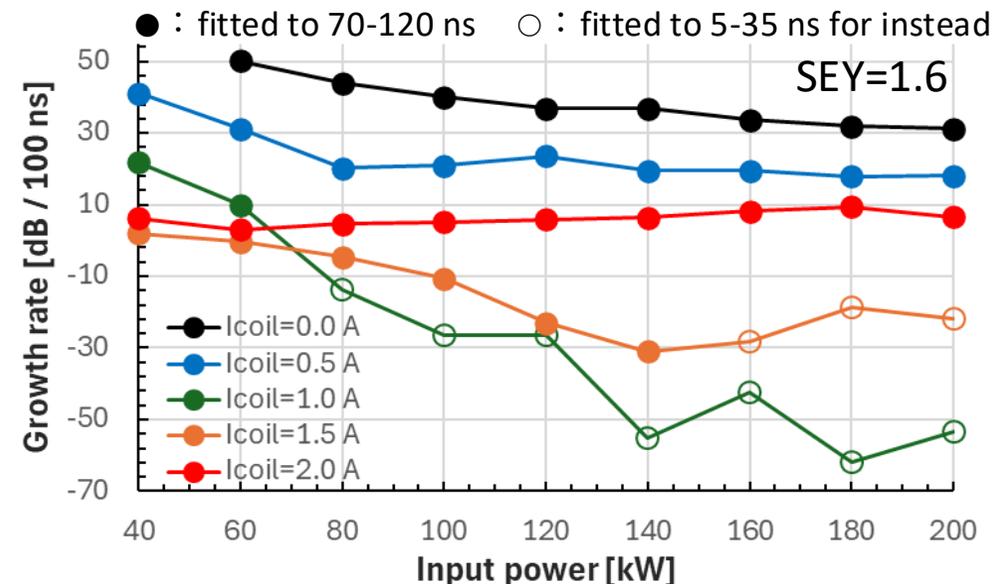
Optimized bias field configuration for the O-ring coupler



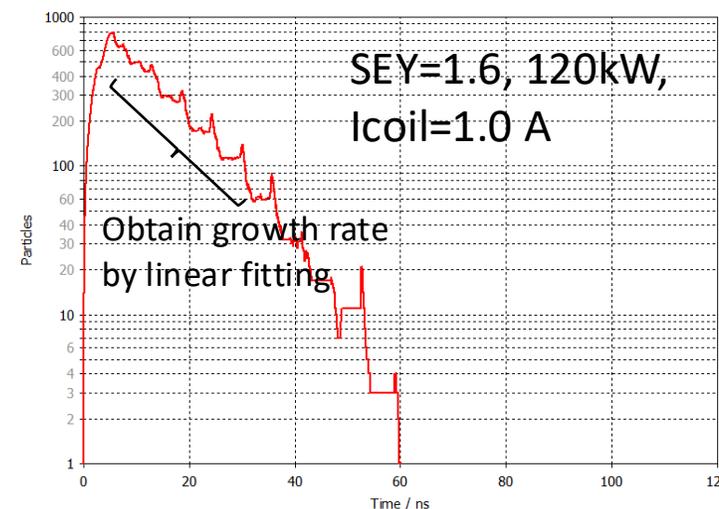
Using energy dependency of secondary yield

Optimized bias Bz field can suppress MP up to MP-free region (Growth rate < 0)

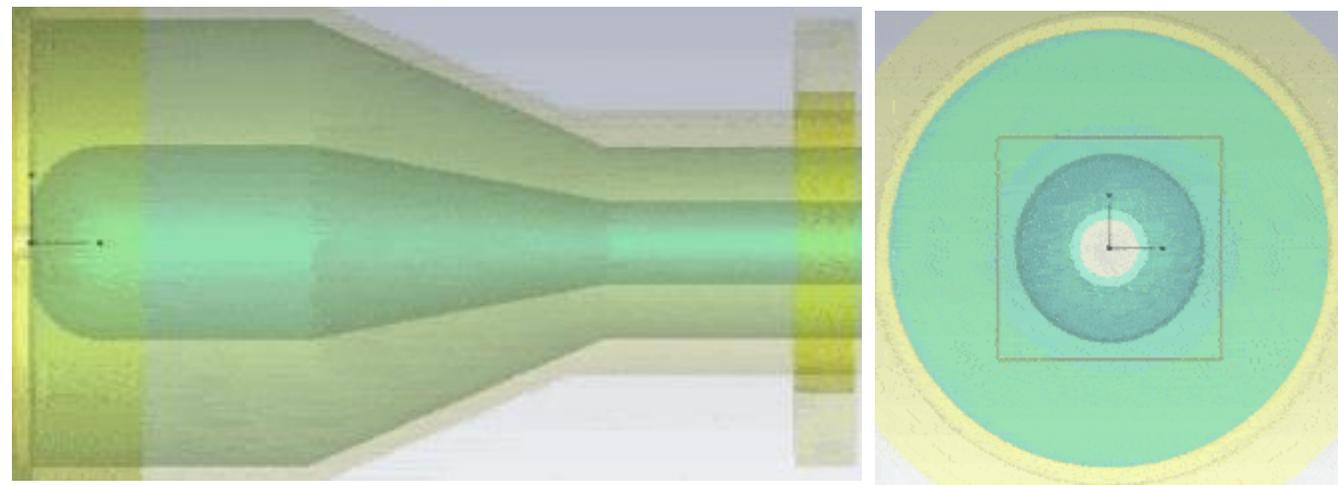
- In this case, around 50-75 Gauss of bias B field can achieve MP-free for almost the entire region of input power.



Growth rate with bias field for the O-ring coupler

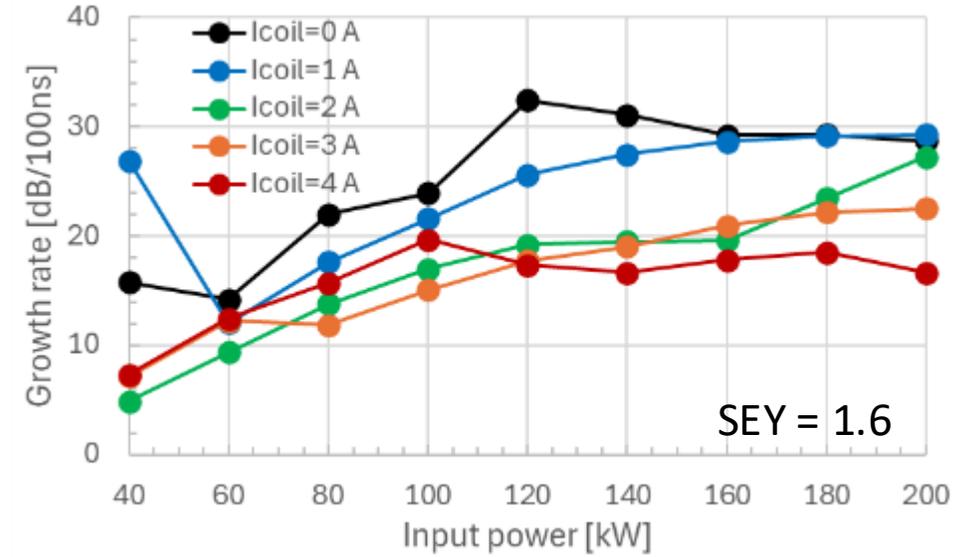


Particle decrease of a MP free case

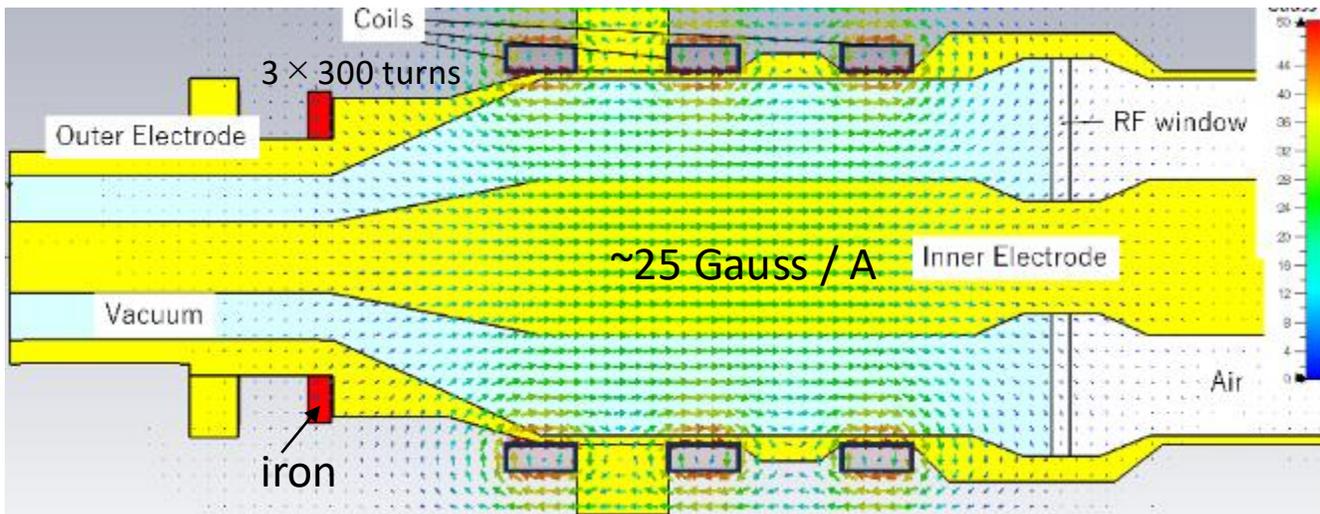


Electron motion; SEY=1.6, 140kW, Icoil = 1.0 A (Bz ~ 50 Gauss)

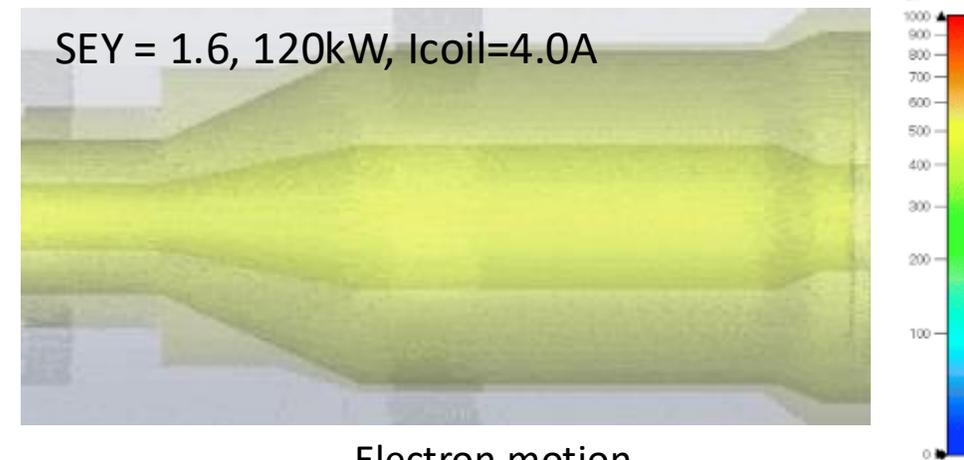
- With enough field more than 2A of coil current (50 Gauss) at the straight pipe, it can effectively decrease the growth rate.
- The currently considered bias fields could not achieve MP-free (growth rate < 0), as the coil configuration still not well optimized.
 - There is some difficulty in coil setting since the brazed coupler has a bit more complicated structure than the O-ring couplers.
 - The field configuration is specified so as to generate B_z fields in the straight pipe region of the coupler



Growth rate with bias field for brazed coupler (the field configuration is still not well optimized)



Bias field configuration

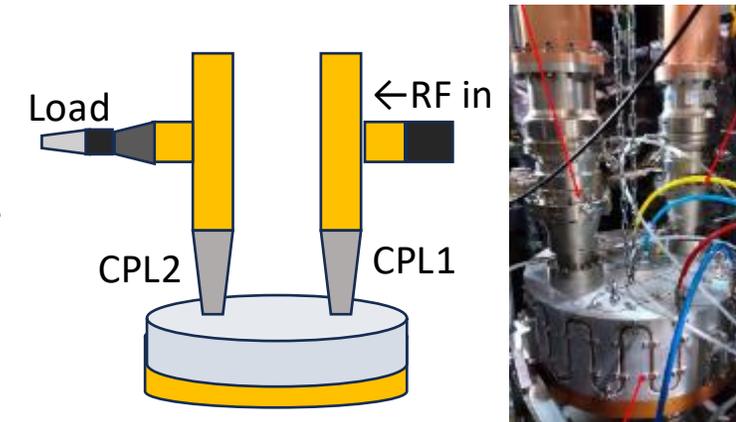
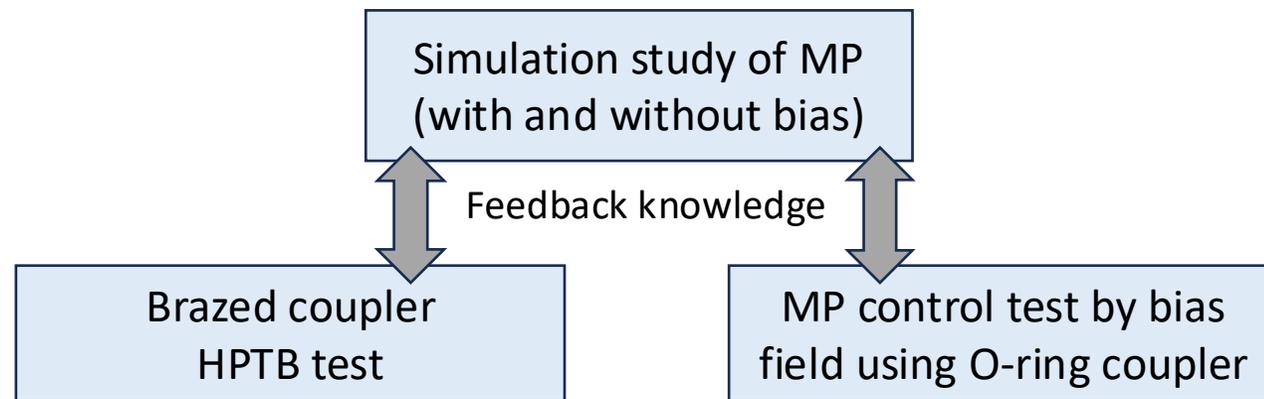


Electron motion

- Testing of the brazed couplers are ongoing and going better than the simulations. (details will be reported by others)
 - CW run in 4 hours with 180 kW(nominal input) has been demonstrated.
 - MP region is limited to several input power bands → e.g. 60-80 kW and 120-150kW
 - Not all couplers have the same behavior (some present more pronounced MP than others)

Fitting secondary yield distribution is needed, since they seems to have lower secondary yield than that in a literature due to surface procession or conditioning.

- Preparation of bias field test with using the O-ring couplers is also ongoing.



High power test bench (HPTB): test of new couplers is ongoing



Test of bias field effect with using the O-ring coupler is prepared

Summary

- Simulations of O-ring/brazed RF coupler have done.
 - Brazed coupler shows better characteristics especially in low power region
 - MP around the RF window is important for the both designs, especially in high power region.
 - MP around taper end is important for low power region
 - 2-surface MP at the 120-140 kW
- Tests of brazed couplers are ongoing, with better behavior than the simulations
 - MP region is limited to several power bands in the tests.
 - It seems to have lower secondary yield than a literature by surface processing or conditioning.
- MP control by external B-field bias simulations
 - It showed promising result especially for the O-ring coupler
 - Preparation for test of the bias is ongoing

Future task

- Secondary emission parameter fitting to the brazed-coupler test results.
- Optimization of bias B-field for the brazed-couplers.
- Validation of the couplers with the RFQ

Thank you!